

1

2

3

4

5

6

7

8

ROHS G753

A±0.20

2.00

SQ 0.500

Pin2

5.80

C±0.25

B±0.30

7.30

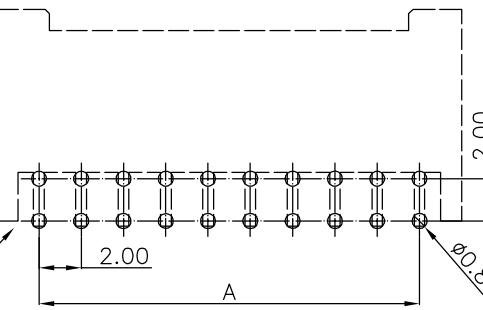
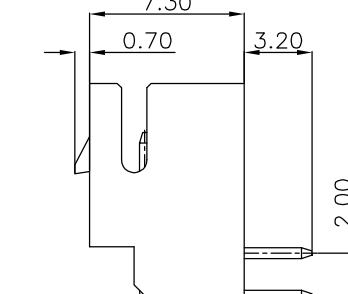
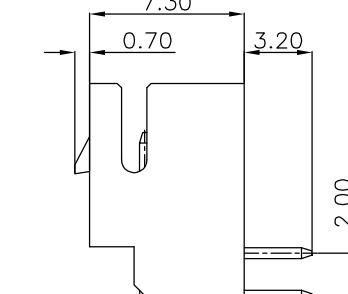
0.70

3.20

10.00

7.70

2.00



Conn.line
RECOMMENDED PCB LAYOUT
(TOLERANCE: ± 0.05)

E				
D				
C				
B				
A	2.0	修改塑胶结构	Huyatao	
NO.	DATE	DESCRIPTION	APPROVAL	

DRAWING:
Hu yatao

CHECKED:
Tony

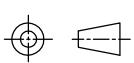
APPROVAL:
Yang jie

GENERAL TOLERANCE
.X:= ± 0.30 .X°:= $\pm 2^\circ$
.XX:= ± 0.20 .XX°:= $\pm 1^\circ$
.XXX:= ± 0.10 .XXX°:= $\pm 0.5^\circ$

UNIT: MM

PROJECTION:

SCALE: N/A



SHEET: 1/1



CHIN-BAN
electronics (H.K.) co., Ltd

DESCRIPTION:
2.00mm Wire To Board Wafer Double Row 90°

PART NO: WB2013DR-XXT3B-P REV: 2.0

CUSTOMER NO: Y04122181675 SIZE: A4

1.ELECTRICAL SPECIFICATIONS:

- 1.1 Rated current and voltage(额定电流): 3.0A 250V AC(r.m.s)
- 1.2 Dielectric Withstanding Voltage(耐电压) : 1000V AC for one minute
- 1.3 Contact Resistance(接触电阻) : 30mΩ max
- 1.4 Insulation Resistance(绝缘电阻) : 1000MΩ min
- 1.5 Operating Temperature(工作温度) : -25°C ~ 85°C

2.MATERIAL SPECIFICATION:

- 2.1 Insulator Material(绝缘体材质): PA46 UL94V-0
- 2.2 Contact Material(端子材质): Brass,Tin Plated

▲ Non-tooled parts

No.of positions DIM list:

CONTACTS	DIMENSIONS		
	A	B	C
4	2.00	6.00	4.90
6	4.00	8.00	6.90
8	6.00	10.00	8.90
10	8.00	12.00	10.90
12	10.00	14.00	12.90
14	12.00	16.00	14.90
16	14.00	18.00	16.90
18	16.00	20.00	18.90
20	18.00	22.00	20.90
22	20.00	24.00	22.90
24	22.00	26.00	24.90
26	24.00	28.00	26.90
28	26.00	30.00	28.90
30	28.00	32.00	30.90
32	30.00	34.00	32.90
34	32.00	36.00	34.90
36	34.00	38.00	36.90
38	36.00	40.00	38.90
40	38.00	42.00	40.90
60	58.00	62.00	60.90